





## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 09/756,971  
Filing Date ..... January 9, 2001  
Inventor ..... Salman Akram  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2827  
Examiner ..... David A. Zarneke  
Attorney's Docket No. .... MI22-1572  
Title: Methods of Forming Board-On-Chip Packages

### EXAMINER INTERVIEW SUMMARY OF JANUARY 23, 2003

To: Assistant Commissioner for Patents  
Washington, D.C. 20231

From: D. Brent Kenady  
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Applicant's representative held an interview with Examiner David Zarneke on January 23, 2003. Applicant's representative would like to express his great appreciation for Examiner Zarneke providing the time to discuss issues regarding the above-referenced patent application.

Applicant's representative and the Examiner discussed the possibility of amending and canceling claims to bring the case into allowance. No agreement was reached as to any amendments or canceling of claims.

Respectfully submitted,

Dated: 2-6-03

By: D. Brent Kenady  
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